# **IRL540**

Vishay Siliconix



**TO-220AB** 

**PRODUCT SUMMARY** 

 $V_{DS}$  (V)  $R_{DS(on)}$  ( $\Omega$ )

Q<sub>gs</sub> (nC)

Q<sub>gd</sub> (nC)

Q<sub>q</sub> (Max.) (nC)

Configuration

# **Power MOSFET**

S

N-Channel MOSFET

0.077

100

64

9.4

27

Single

 $V_{GS} = 5.0 V$ 

## FEATURES

- Dynamic dV/dt rating
- · Repetitive avalanche rated
- Logic-level gate drive
- R<sub>DS(on)</sub> specified at V<sub>GS</sub> = 4 V and 5 V
- 175 °C operating temperature
- Fast switching
- Ease of paralleling
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

#### Note

\* This datasheet provides information about parts that are RoHS-compliant and / or parts that are non RoHS-compliant. For example, parts with lead (Pb) terminations are not RoHS-compliant. Please see the information / tables in this datasheet for details

### DESCRIPTION

Third generation power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The TO-220AB package is universally preferred for all commercial-industrial applications at power dissipation levels to approximately 50 W. The low thermal resistance and low package cost of the TO-220AB contribute to its wide acceptance throughout the industry.

ORDERING INFORMATION	
Package	TO-220AB
Lead (Pb)-free	IRL540PbF
Lead (Pb)-free and halogen-free	IRL540PbF-BE3

ABSOLUTE MAXIMUM RATINGS ( $T_C$	= 25 °C, unl	less otherwis	se noted)			
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-source voltage			V <sub>DS</sub>	100	v	
Gate-source voltage			V <sub>GS</sub>	± 10	v	
Continuous drain current	V <sub>GS</sub> at 5 V	$T_{\rm C} = 25 \ ^{\circ}{\rm C}$ $T_{\rm C} = 100 \ ^{\circ}{\rm C}$	- I <sub>D</sub>	28		
		T <sub>C</sub> = 100 °C		20	А	
Pulsed drain current <sup>a</sup>			I <sub>DM</sub>	110		
Linear derating factor				1.0	W/°C	
Single pulse avalanche energy <sup>b</sup>			E <sub>AS</sub>	440	mJ	
Repetitive avalanche current <sup>a</sup>			I <sub>AR</sub>	28	A	
Repetitive avalanche energy <sup>a</sup>			E <sub>AR</sub>	15	mJ	
Maximum power dissipation	T <sub>C</sub> =	25 °C	PD	150	W	
Peak diode recovery dV/dt <sup>c</sup>			dV/dt	5.5	V/ns	
Operating junction and storage temperature range			T <sub>J</sub> , T <sub>stg</sub>	-55 to +175	°C	
Soldering recommendations (peak temperature) <sup>d</sup>	For 10 s		-	300 <sup>d</sup>	-0	
Mounting torque	6-32 or M3 screw			10	lbf ∙ in	
				1.1	N⋅m	

#### Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11)

b.  $V_{DD}$  = 25 V, starting T<sub>J</sub> = 25 °C, L = 841 µH, R<sub>g</sub> = 25  $\Omega$ , I<sub>AS</sub> = 28 A (see fig. 12c)

c.  $I_{SD} \le 28$  A, dl/dt  $\le 170$  A/µs,  $V_{DD} \le V_{DS}$ ,  $T_J \le 175$  °C

d. 1.6 mm from case

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THERMAL RESISTANCE RAT	INGS									
PARAMETER	SYMBOL	TYP.		MAX.		UNIT				
Maximum junction-to-ambient	R <sub>thJA</sub>	- 62			°C/W					
Case-to-sink, flat, greased surface	R <sub>thCS</sub>	0.50 - - 1.0								
Maximum junction-to-case (drain)	R <sub>thJC</sub>									
	÷	÷								
<b>SPECIFICATIONS</b> ( $T_J = 25 \ ^{\circ}C$ , 0	unless otherw	vise noted)								
PARAMETER	SYMBOL	TES	T CONDITI	ONS	MIN.	TYP.	MAX.	UNIT		
Static		1			•	•		1		
Drain-source breakdown voltage	V <sub>DS</sub>	V <sub>GS</sub> =	= 0 V, I <sub>D</sub> = 2	50 µA	100	-	-	V		
V <sub>DS</sub> temperature coefficient	$\Delta V_{DS}/T_{J}$	Reference	e to 25 °C,	l <sub>D</sub> = 1 mA	-	0.12	-	V/°C		
Gate-source threshold voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> =	$V_{DS} = V_{GS}, I_D = 250 \ \mu A$			-	2.0	V		
Gate-source leakage	I <sub>GSS</sub>	1	$V_{GS} = \pm 10 \text{ V}$			-	± 100	nA		
		$V_{DS} = 100 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$ $V_{DS} = 80 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 150 \text{ °C}$		-	-	25	<u> </u>			
Zero gate voltage drain current	IDSS			T <sub>J</sub> = 150 °C	-	-	250	μA		
Drain-source on-state resistance	_	V <sub>GS</sub> = 5.0 V	I <sub>D</sub>	= 17 A <sup>b</sup>	-	-	0.077			
	R <sub>DS(on)</sub>	V <sub>GS</sub> = 4.0 V	I <sub>D</sub>	= 14 A <sup>b</sup>	-	-	0.11	Ω		
Forward transconductance	<b>g</b> <sub>fs</sub>	V <sub>DS</sub> = 50 V, I <sub>D</sub> = 17 A			12	-	-	S		
Dynamic		1			•	<b>I</b>	I			
Input capacitance	C <sub>iss</sub>	N 0.V		-	2200	-				
Output capacitance	C <sub>oss</sub>		$V_{GS} = 0 V,$ $V_{DS} = 25 V,$ f = 1.0 MHz, see fig. 5		-	560	-	pF		
Reverse transfer capacitance	C <sub>rss</sub>	f = 1.			-	140	-			
Total gate charge	Qg			-	-	64	nC			
Gate-source charge	Q <sub>gs</sub>	$V_{GS} = 5.0 V$ $I_D = 28 A, V_{DS}$ see fig. 6 an			-	-		9.4		
Gate-drain charge	Q <sub>gd</sub>				-	-		27		
Turn-on delay time	t <sub>d(on)</sub>	V <sub>DD</sub> = 50 V, I <sub>D</sub> = 28 A,			-	8.5	-			
Rise time	t <sub>r</sub>			-	170	-				
Turn-off delay time	t <sub>d(off)</sub>	$R_g = 9.0 \Omega$ ,	$R_g = 9.0 \Omega$ , $R_D = 1.7 \Omega$ , see fig. $10^b$		-	35	-	ns		
Fall time	t <sub>f</sub>	1			-	80	-			
Internal drain inductance	L <sub>D</sub>	Between lead, 6 mm (0.25") from package and center of die contact			-	4.5	-	nH		
Internal source inductance	L <sub>S</sub>				-	7.5	-			
Drain-Source Body Diode Characterist	cs	1				1				
Continuous source-drain diode current	Is	MOSFET symbol showing the		-	-	28	A			
Pulsed diode forward current <sup>a</sup>	I <sub>SM</sub>	integral reverse p - n junction diode			-	-		110		
Body diode voltage	V <sub>SD</sub>	$T_J = 25 \ ^{\circ}C, \ I_S = 28 \ A, \ V_{GS} = 0 \ V^b$			-	-	2.5	V		
Body diode reverse recovery time	t <sub>rr</sub>	T <sub>J</sub> = 25 °C, I <sub>F</sub> = 28 A, dl/dt = 100 A/μs <sup>b</sup>		-	200	260	ns			
Body diode reverse recovery charge	Q <sub>rr</sub>	$r_{\rm J} = 20$ 0, $r_{\rm F} = 20$ A, $u/ut = 100$ A/µs <sup>2</sup>			-	1.7	2.90	μC		
Forward turn-on time	t <sub>on</sub>	Intrinsic turn-on time is negligible (turn			-on is dor	minated b	y L <sub>S</sub> and L <sub>D</sub> )			

#### Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11)

b. Pulse width  $\leq$  300 µs; duty cycle  $\leq$  2 %

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## TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

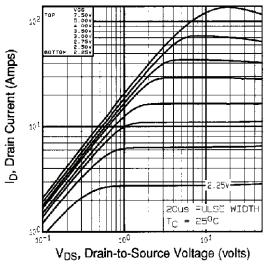
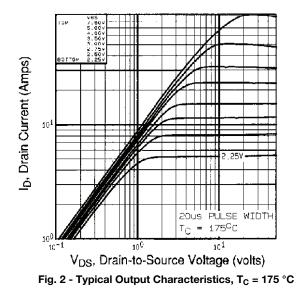
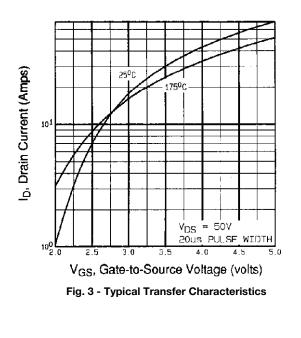


Fig. 1 - Typical Output Characteristics,  $T_C = 25 \ ^{\circ}C$ 





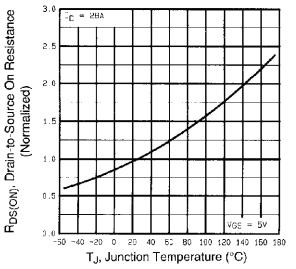


Fig. 4 - Normalized On-Resistance vs. Temperature

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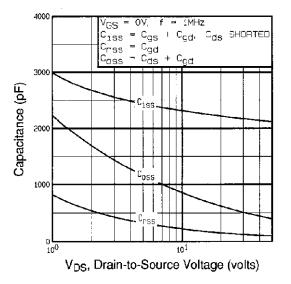
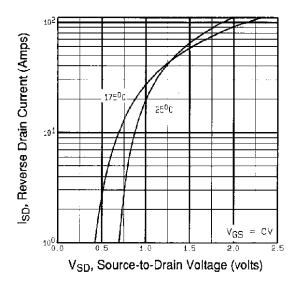
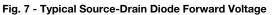


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage





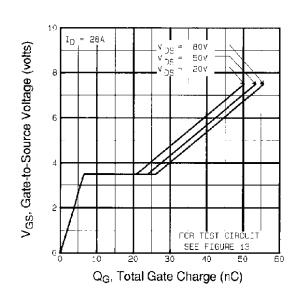


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

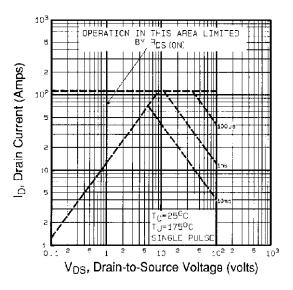


Fig. 8 - Maximum Safe Operating Area



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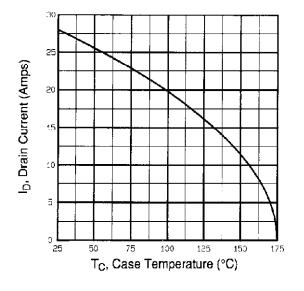


Fig. 9 - Maximum Safe Operating Area

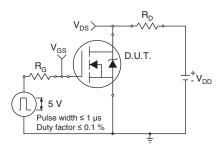


Fig. 10a - Switching Time Test Circuit

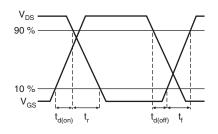


Fig. 10b - Switching Time Waveforms

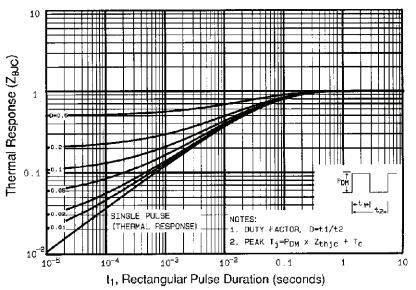
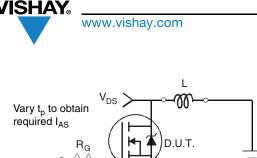


Fig. 3 - Maximum Effective Transient Thermal Impedance, Junction-to-Case

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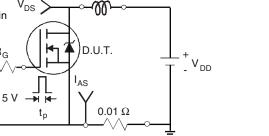


Fig. 12a - Unclamped Inductive Test Circuit

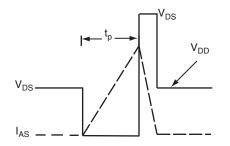


Fig. 12b - Unclamped Inductive Waveforms

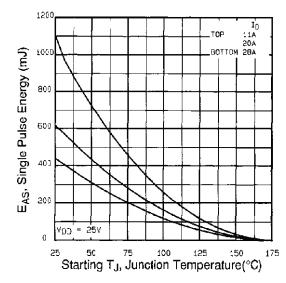


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

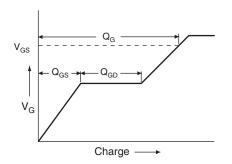
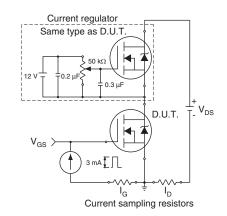


Fig. 13a - Basic Gate Charge Waveform





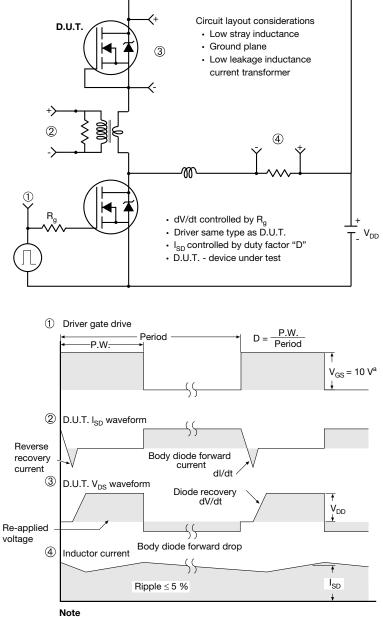
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### Peak Diode Recovery dV/dt Test Circuit



a.  $V_{GS} = 5 V$  for logic level devices

Fig. 14 - For N-Channel

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